DSF8025SE/DSF8025SG

Fast Recovery Diode

DS6153-1 July 2014 (LN31793)

FEATURES

- Double Side Cooling
- High Surge Capability
- Low Recovery Charge

APPLICATIONS

- Induction Heating
- High Frequency Rectification
- Snubber, Antiparallel and FWD for GTO

VOLTAGE RATINGS

Part and Ordering Number	Repetitive Peak Voltages V_{RRM} V	Conditions
DSF8025SE25 DSF8025SG25	2500	$V_{RSM} = V_{RRM}+100V$
DSF8025SE24 DSF8025SG24	2400	
DSF8025SE23 DSF8025SG23	2300	
DSF8025SE22 DSF8025SG22	2200	
DSF8025SE21 DSF8025SG21	2100	
DSF8025SE20 DSF8025SG20	2000	

Lower voltage grades available.

ORDERING INFORMATION

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

DSF8025SE20 for a 2000V device in an "E" outline

Note: Please use the complete part number when ordering and quote this number in any future correspondence relating to your order

KEY PARAMETERS

V_{RRM}	**2500V**
$I_{F(AV)}$	**650A**
I_{FSM}	**7500A**
Q_r	**540µC**
t_{rr}	**5.0µs**

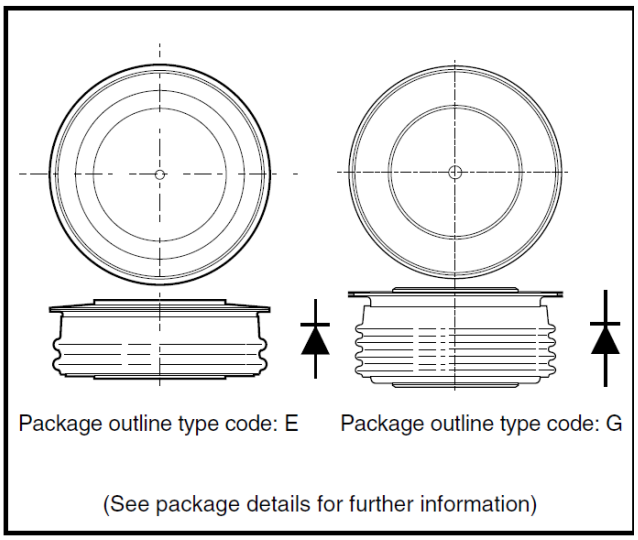


Fig. 1 Package outline

CURRENT RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
Double Side Cooled				
$I_{F(AV)}$	Mean forward current	Half wave resistive load T_{case}= 65°C	650	A
$I_{F(RMS)}$	RMS value	T_{case}= 65°C -	1020	A
I_F	Continuous (direct) on-state current	T_{case}= 65°C -	785	A
Single Side Cooled (Anode side)				
$I_{F(AV)}$	Mean forward current	Half wave resistive load T_{case}= 65°C -	385	A
$I_{F(RMS)}$	RMS value	T_{case}= 65°C --	604	A
I_F	Continuous (direct) on-state current	T_{case}= 65°C --	465	A

SURGE RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
I_{FSM}	Surge (non-repetitive) on-state current	10ms half sine, T_{case} = 150°C	6.0	kA
I^2t	I^2t for fusing	V_R = 50% V_{RRM}	180	kA^2s
I_{FSM}	Surge (non-repetitive) on-state current	10ms half sine, T_{case} = 150°C	7.5	kA
I^2t	I^2t for fusing	V_R = 0	281	kA^2s

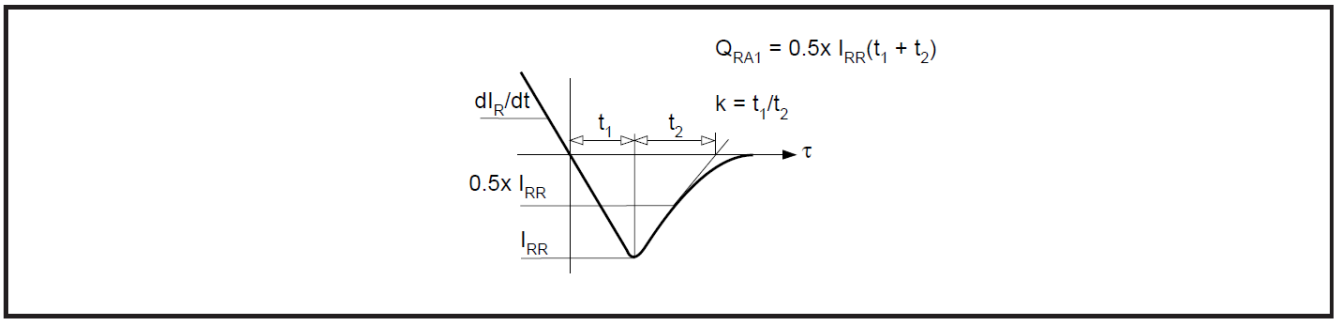
THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Conditions		Min.	Max.	Units
$R_{th(j-c)}$	Thermal resistance – junction to case	Double side cooled	DC	-	0.047	°C/W
		Single side cooled	Anode DC	-	0.094	°C/W
			Cathode DC	-	0.094	°C/W
$R_{th(c-h)}$	Thermal resistance – case to heatsink	Clamping force 8.0kN	Double side	-	0.018	°C/W
		(with mounting compound)	Single side	-	0.036	°C/W
T_{vj}	Virtual junction temperature	On-state (conducting)		-	150	°C
		Reverse (blocking)		-	150	°C
T_{stg}	Storage temperature range			-55	175	°C
F_m	Clamping force			7.0	9.0	kN

CHARACTERISTICS

Symbol	Parameter	Test Conditions	Typ.	Max.	Units
V_{FM}	Forward voltage	At 1000A peak, T_{case} = 25°C	-	2.3	V
I_{RM}	Peak reverse current	At V_{DRM}, T_{case} = 150°C	-	50	mA
t_{rr}	Reverse recovery time	I_F = 750A, dI_{RR}/dt =100A/µs T_{case} =125°C, V_R =100V		5.0	µs
Q_S	Total stored charge		-	540	µC
I_{rr}	Peak reverse recovery current			235	A
K	Softness Factor		1.8	-	-
V_{TO}	Threshold voltage	At T_{vj} = 150°C	-	1.48	V
r_T	Slope resistance	At T_{vj} =150°C	-	0.8	mΩ
V_{FRM}	Forward recovery voltage	Di/dt = 1000A/us, T_j = 125°C	70		V

DEFINITION OF K FACTOR AND Q_{RA1}



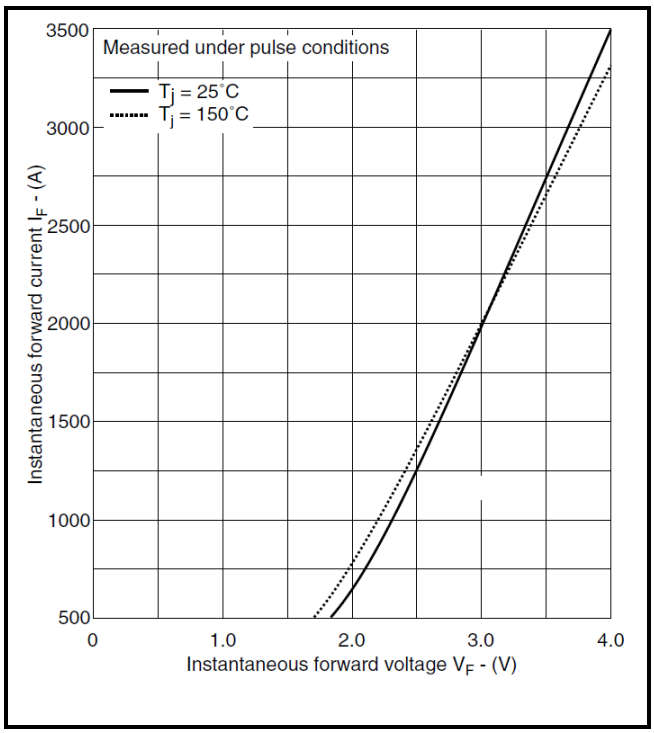


Fig.2 Maximum (limit) on-state characteristics

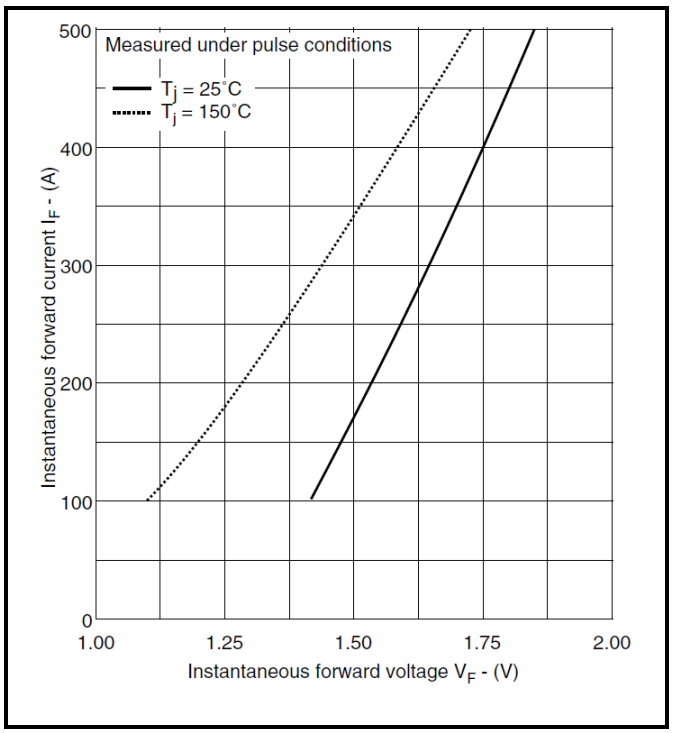


Fig.3 Maximum (limit) on-state characteristics

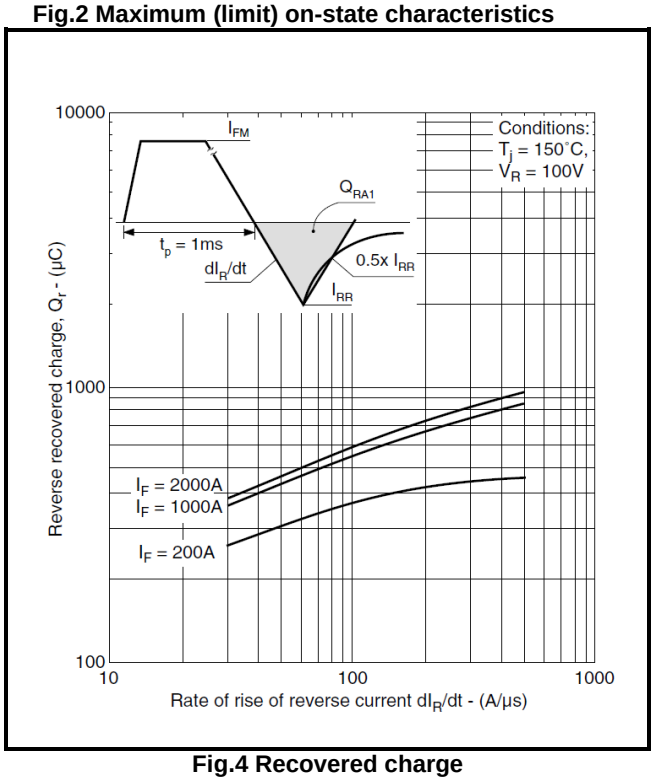


Fig.4 Recovered charge

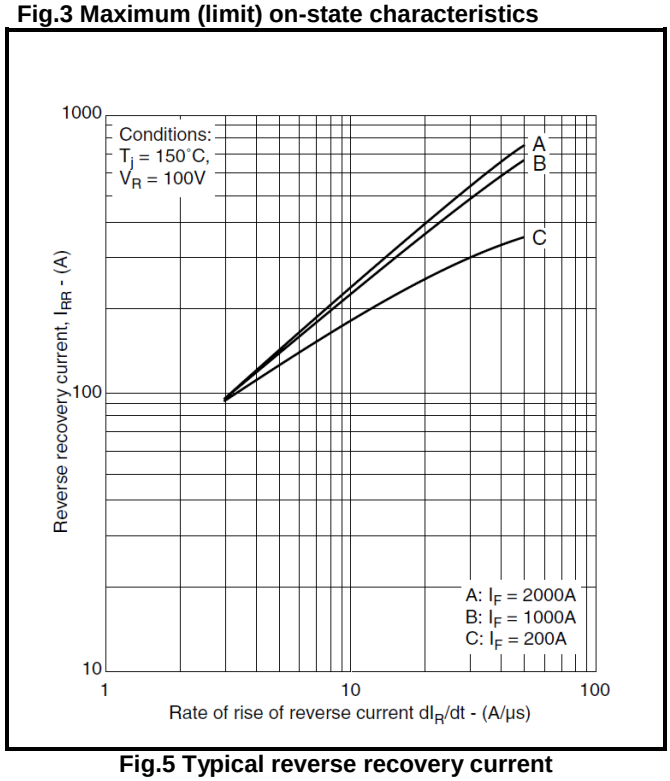


Fig.5 Typical reverse recovery current

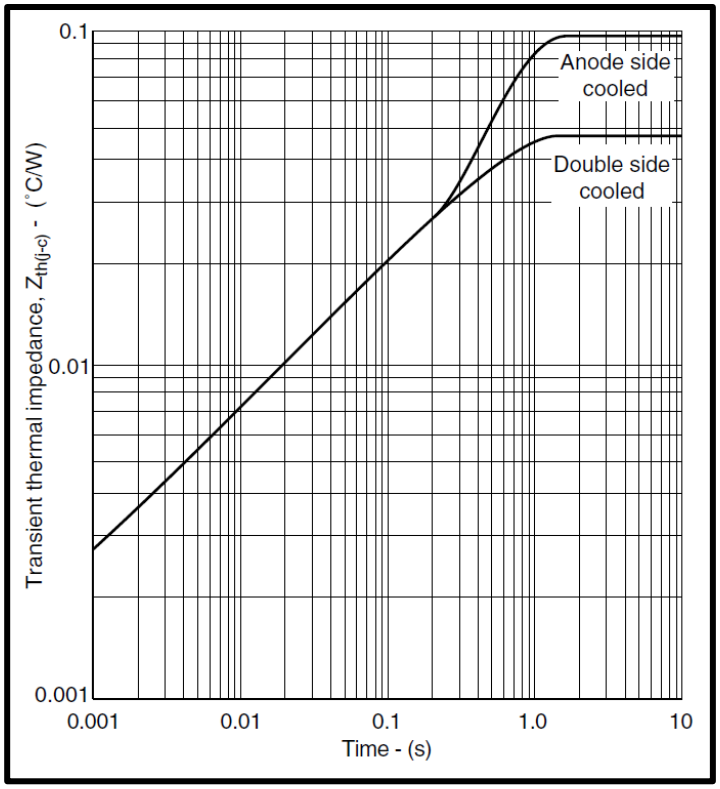


Fig.6 Maximum (limit) transient thermal impedance- junction to case

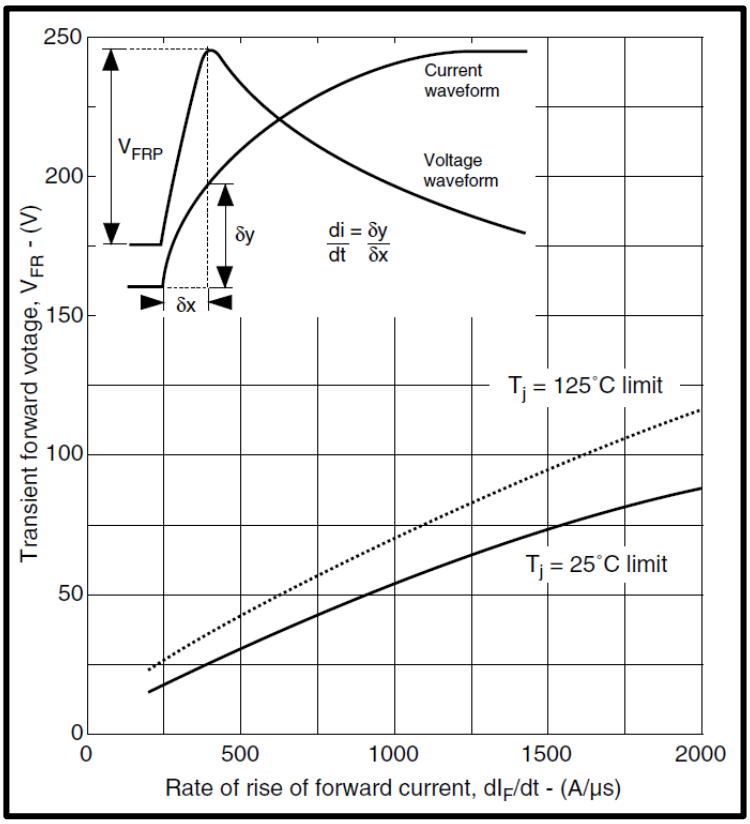
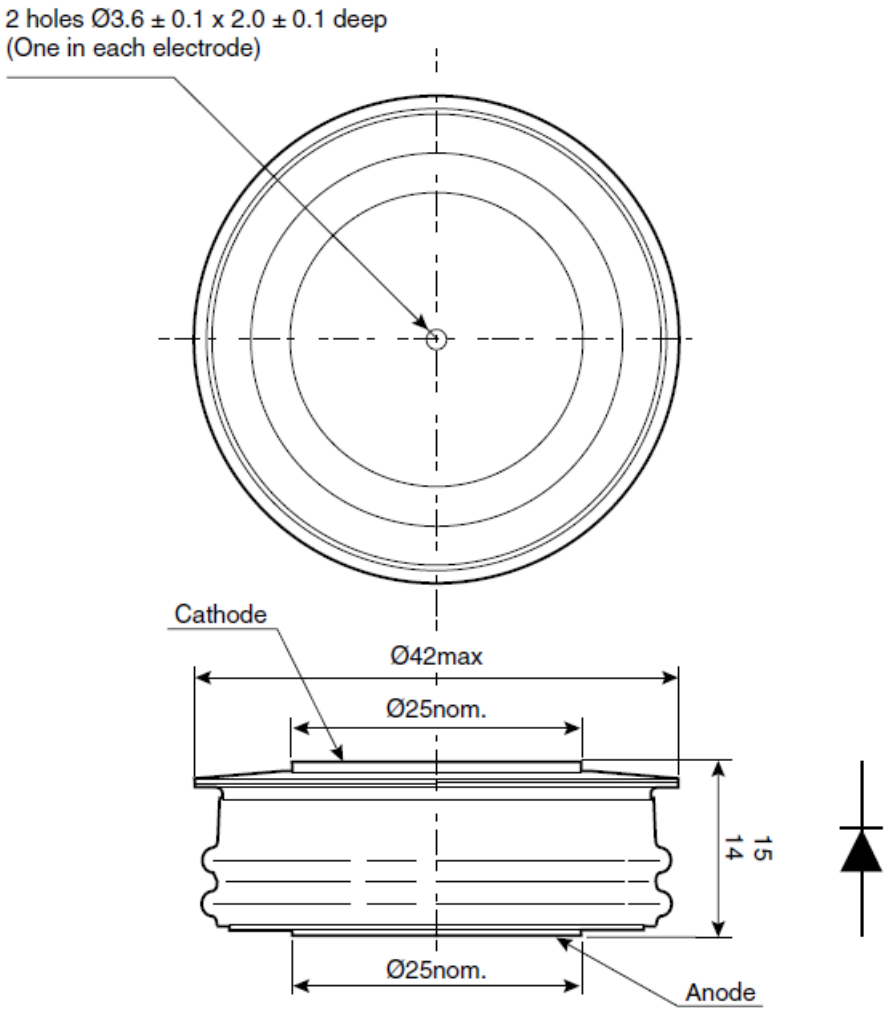


Fig.7 Transient forward voltage

PACKAGE DETAILS

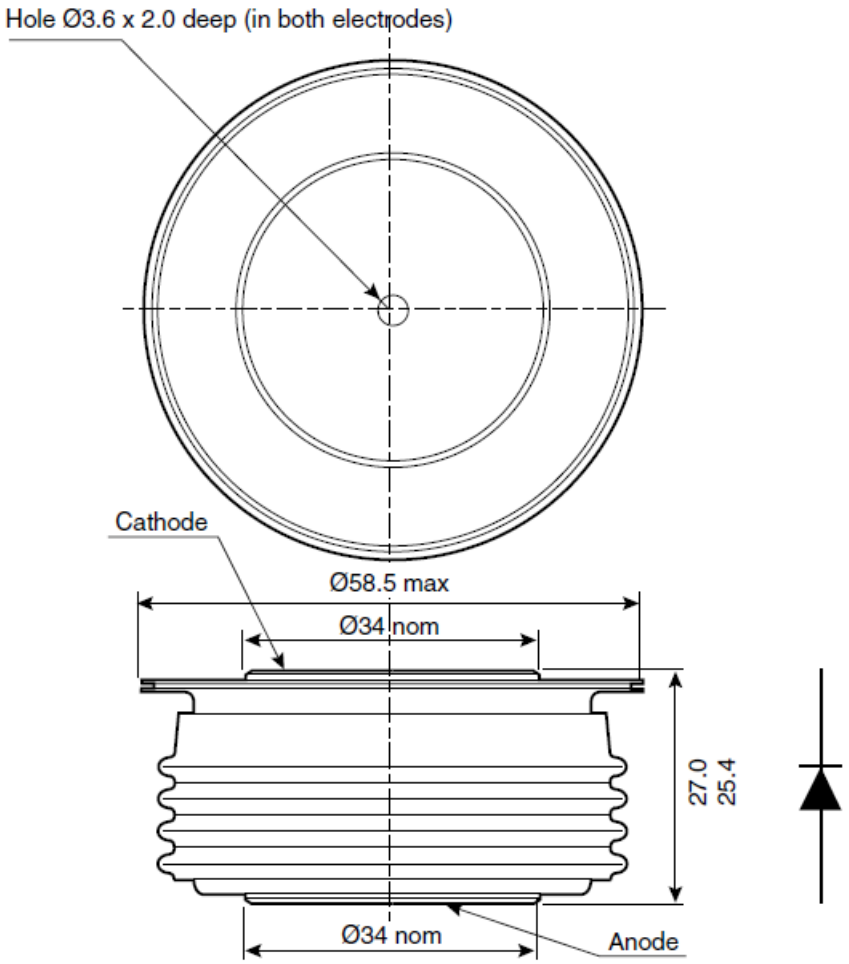
For further package information, please contact Customer Services. All dimensions in mm, unless stated otherwise. DO NOT SCALE.



Nominal weight: 82g
Clamping force: 8kN ±10%
Package maybe supplied with pins and/or tags.

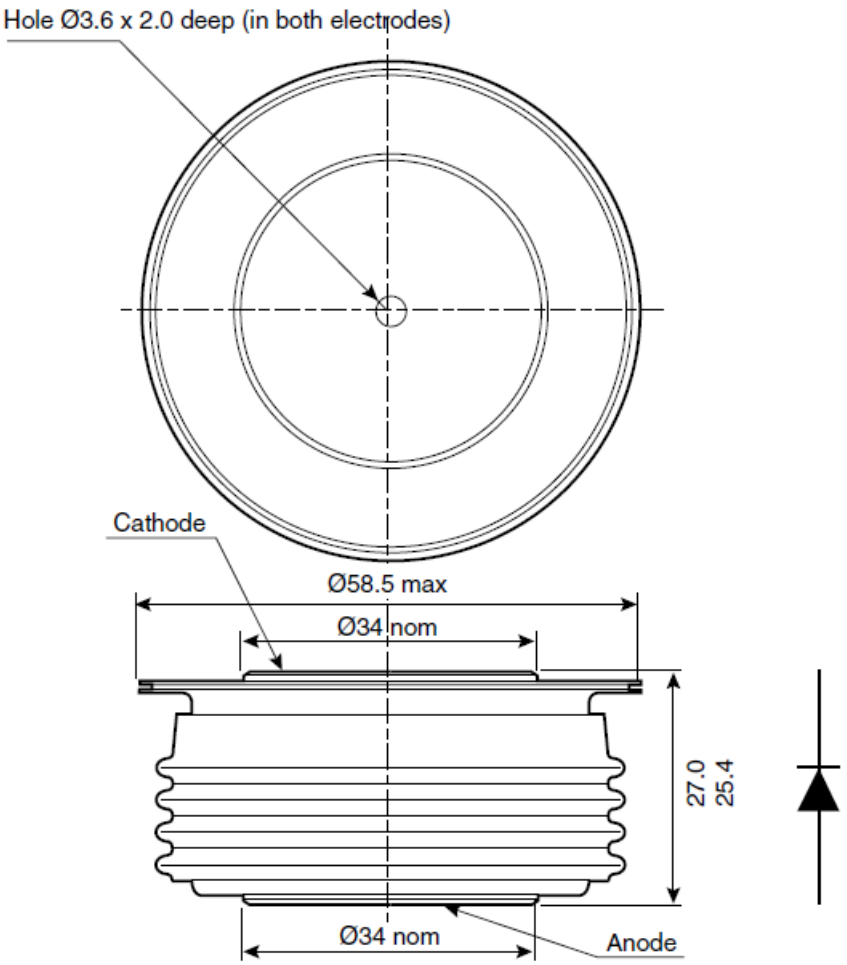
Package outline type code: E

Note: Some packages may be supplied with gate and or tags.



Nominal weight: 250g
Clamping force: 12kN ±10%

Package outine type code: G



Nominal weight: 250g
Clamping force: 12kN ±10%

Package outine type code: G

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